

SEMICONDUCTOR®

FDA38N30

N-Channel UniFETTM MOSFET 300 V, 38 A, 85 m Ω

Features

- $R_{DS(on)}$ = 70 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 19 A
- Low Gate Charge (Typ. 60 nC)
- Low C_{rss} (Typ. 60 pF)
- 100% Avalanche Tested
- ESD Improved Capability
- RoHS Compliant

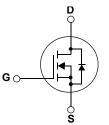
Applications

- PDP TV
- Uninterruptible Power Supply
- AC-DC Power Supply

Description

UniFETTM MOSFET is Fairchild Semiconductor[®], s high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol		Parameter		FDA38N30	Unit	
V _{DSS}	Drain to Source Voltage			300	V	
V _{GSS}	Gate to Source Volta	age		±30	V	
I _D	Davis Ourset	- Continuous ($T_C = 25^{\circ}C$)- Continuous ($T_C = 100^{\circ}C$)		38		
	Drain Current			22	A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	150	А	
E _{AS}	Single Pulsed Avalanche Energy		(Note 2)	1200	mJ	
I _{AR}	Avalanche Current		(Note 1)	38	A	
E _{AR}	Repetitive Avalanche Energy		(Note 1)	31	mJ	
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	4.5	V/ns	
P _D		(T _C = 25°C)		312	W	
	Power Dissipation	- Derate above 25°C		2.5	W/ºC	
T _{J,} T _{STG}	Operating and Stora	Operating and Storage Temperature Range		-55 to +150	°C	
Τ _L		Aximum Lead Temperature for Soldering Purpose, /8" from Case for 5 Seconds		300	°C	

Thermal Characteristics

Symbol	Parameter	FDA38N30	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	0.4	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction-to-Ambient, Max.	40	°C/W

March 2013

FDA38N30
N-Channel
UniFET TM
MOSFET

Device Marking		Device	Package	kage Reel Size Ta		dth	Quantity	
FDA38N30 FDA38N30 TC		TO-3PN	-3PN -			30		
Electric	al Chai	racteristics T _C = 25°C	Cunless otherwise n	oted				
Symbol		Parameter		Conditions	Min	Тур.	Max	Unit
Off Charac	teristics							1
BV _{DSS}	Drain to S	Source Breakdown Voltage	I _D = 250μ	A, V _{GS} = 0V, T _C = 25 ^o C	300	-	-	V
ΔBV_{DSS} / ΔT_{J}		Breakdown Voltage Temperature Coefficient		$I_D = 250 \mu A$, Referenced to 25°C		0.3	-	V/°C
			V _{DS} = 300	V _{DS} = 300V, V _{GS} = 0V		-	1	
I _{DSS} Zero Gate		e Voltage Drain Current	V _{DS} = 240	V _{DS} = 240V, T _C = 125 ^o C		-	10	μA
I _{GSS}	Gate-Bod	y Leakage Current	Leakage Current $V_{GS} = \pm 30V, V_{DS} = 0V$		-	-	±100	nA
On Charac	teristics				ŧ	-+	- I	+
V _{GS(th)}	Gate Thre	eshold Voltage	$V_{DS} = V_{G}$	_S , I _D = 250μA	3.0	-	5.0	V
R _{DS(on)}		Static Drain-Source On-Resistance		V _{GS} = 10V, I _D = 19A		0.07	0.085	Ω
9 _{FS}	Forward 7	Fransconductance	V _{DS} = 20 ⁴	V _{DS} = 20V, I _D = 19A		6.3	-	S
Dynamic C	haracteris	tics						
C _{iss}	Input Cap	acitance			-	2600	-	pF
C _{oss}	Output Ca	Output Capacitance		V _{DS} = 25V, V _{GS} = 0V f = 1MHz		500	-	pF
C _{rss}	Reverse ⁻	Fransfer Capacitance				60	-	pF
Q _{g(tot)}	Total Gate	e Charge at 10V	$V_{-2} = 24$	$V_{DS} = 240V, I_D = 38A$ $V_{GS} = 10V$ (Note 4)		60	-	nC
Q _{gs}	Gate to S	ource Gate Charge				17	-	nC
Q _{gd}	Gate to D	rain "Miller" Charge				28	-	nC
Switching	Characteri	stics						4
t _{d(on)}	Turn-On Delay Time					53	69	ns
t _r	Turn-On F	Rise Time		V_{DD} = 150V, I _D = 38A 		110	143	ns
t _{d(off)}	Turn-Off [Delay Time				118	153	ns
t _f	Turn-Off F	all Time				54	70	ns
Drain-Sour	rce Diode (Characteristics						
I _S	Maximum Continuous Drain to Source D		ce Diode Forwa	iode Forward Current		-	38	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Fo		le Forward Cur	prward Current		-	150	А
V_{SD}	Drain to S	Source Diode Forward Volta	age V _{GS} = 0V	, I _{SD} = 38A	-	-	1.4	V
t _{rr}	Reverse I	Recovery Time		, I _{SD} = 38A	-	315	-	ns
Q _{rr}	Reverse F	Recovery Charge	$dI_F/dt = 1$	dl _F /dt = 100A/µs		4.0	-	μC

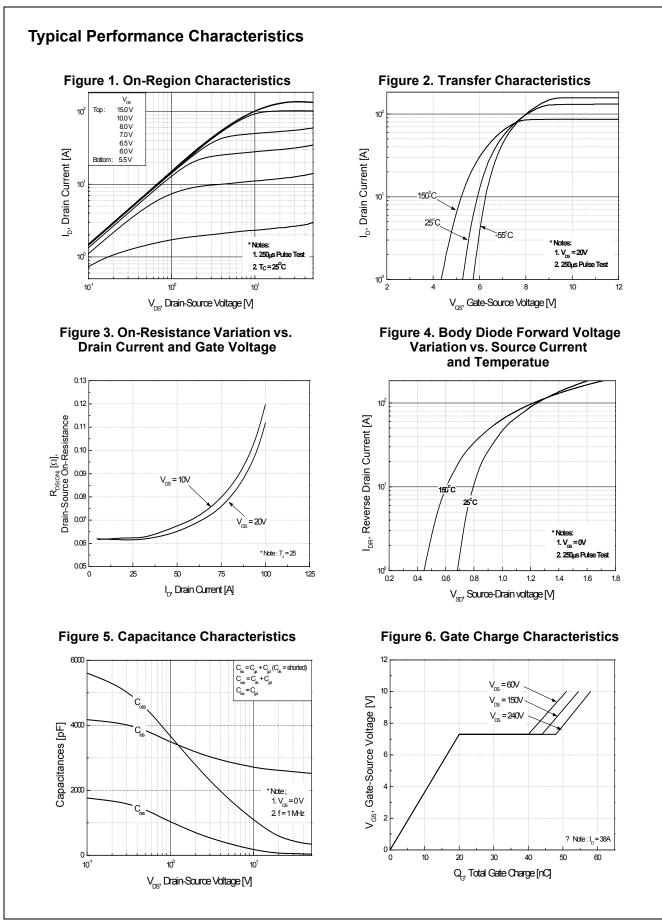
NOTES:

1. Repetitive Rating: Pulse width limited by maximum junction temperature

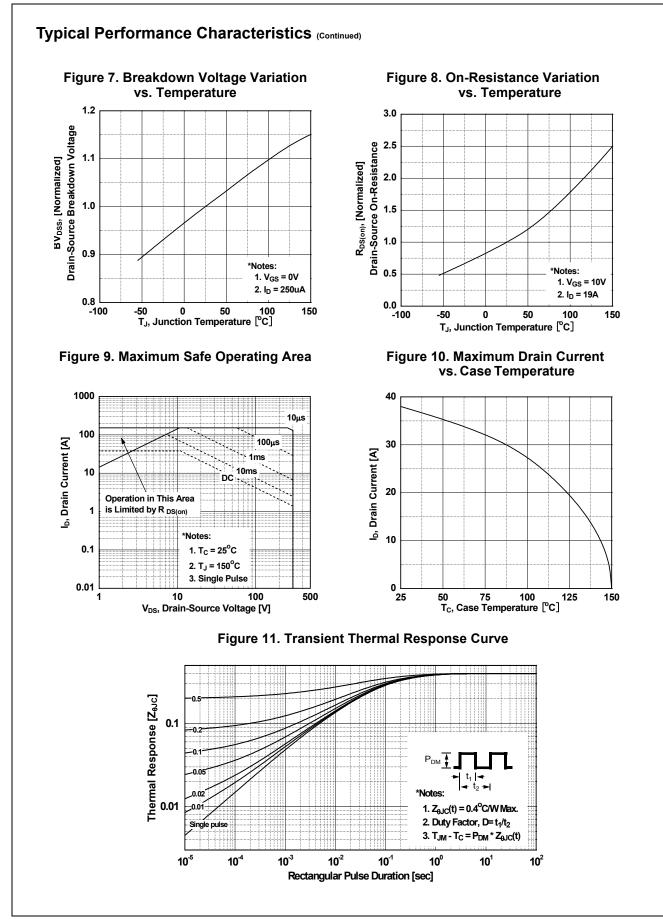
2. L = 1.7mH, I_{AS} = 38A, V_DD = 50V, R_G = 25 Ω , Starting T_J = 25°C

3. I_{SD} \leq 38A, di/dt \leq 200A/µs, V_{DD} \leq BV_{DSS}, Starting T_J = 25°C

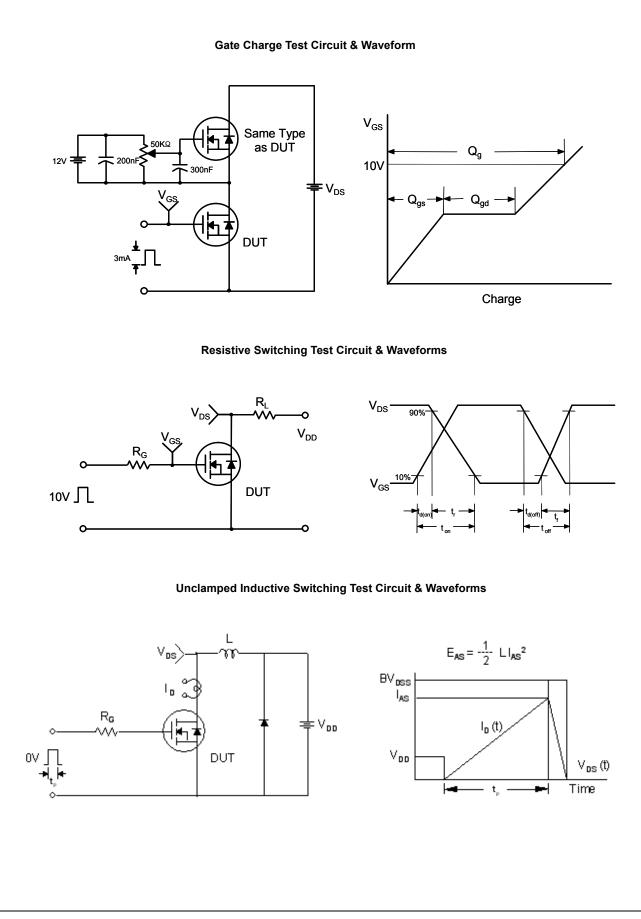
4. Essentially Independent of Operating Temperature Typical Characteristics



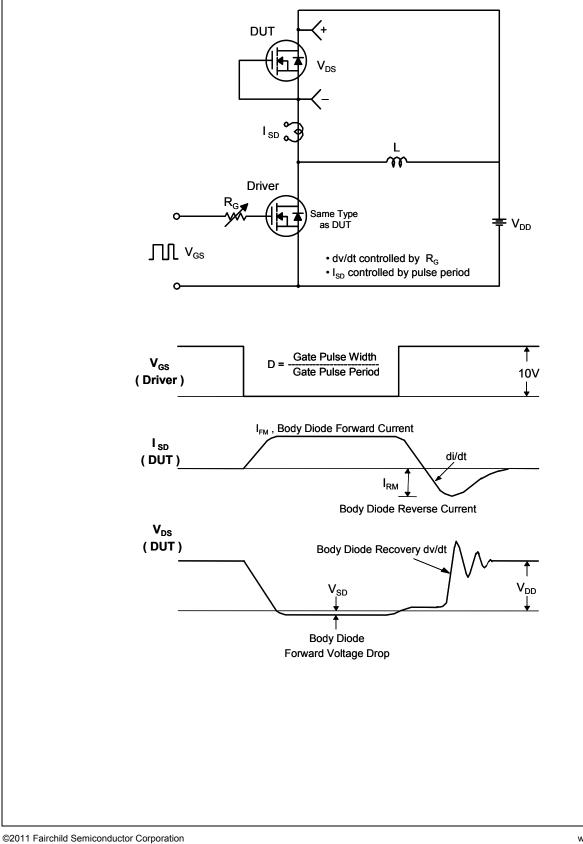
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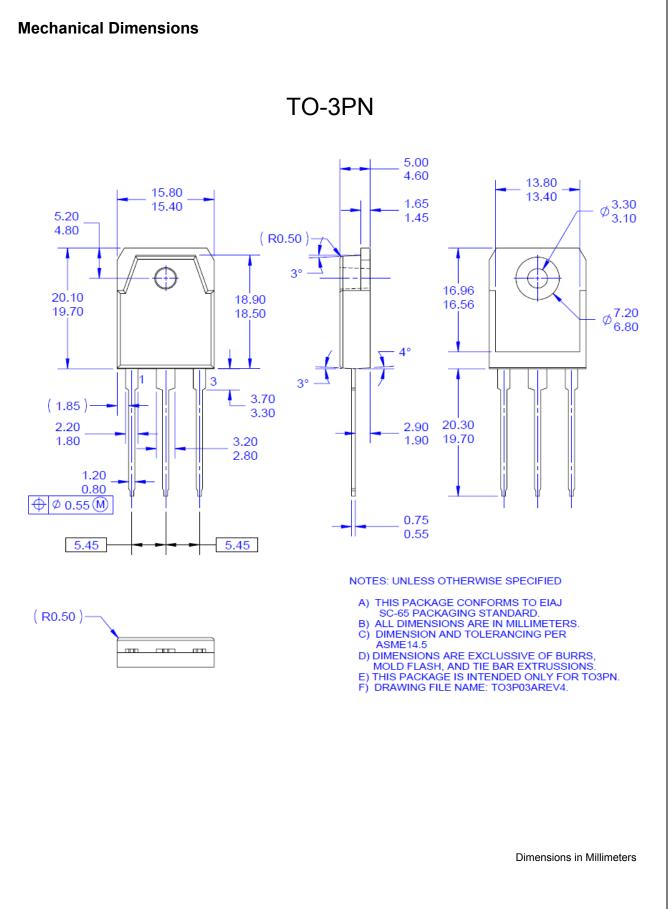
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Peak Diode Recovery dv/dt Test Circuit & Waveforms





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